

Application Note

TLE7251V

About this document

Scope and purpose

This document provides application information for the transceiver TLE7251V from Infineon Technologies AG as Physical Medium Attachment within a Controller Area Network (CAN).

This document contains information about:

- set-ups for CAN application
- mode control
- fail safe behavior
- power supply concepts
- power consumption aspects

This document refers to the data sheet of the Infineon Technologies AG CAN Transceiver TLE7251V.

Note: The following information is given as a hint for the implementation of our devices only and shall not be regarded as a description or warranty of a certain functionality, condition or quality of the device.

Intended audience

This document is intended for engineers who develop applications.

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CAN Application

1 CAN Application

With the growing number of electronic modules in cars the amount of communication between modules increases. In order to reduce wires between the modules CAN was developed. CAN is a Class-C, multi master serial bus system. All nodes on the bus system are connected via a two wire bus. A termination of $R_T = 120 \Omega$ or a split termination ($R_{T/2} = 60 \Omega$ and $C_T = 4.7 \text{ nF}$) on two nodes within the bus system is recommended.

Typically an ECU consists of:

- power supply
- microcontroller with integrated CAN protocol controller
- CAN transceiver

The CAN protocol uses a lossless bit-wise arbitration method of conflict resolution. This requires all CAN nodes to be synchronized. The complexity of the network can range from a point-to-point connection up to hundreds of nodes. A simple network concept using CAN is shown in [Figure 1](#).

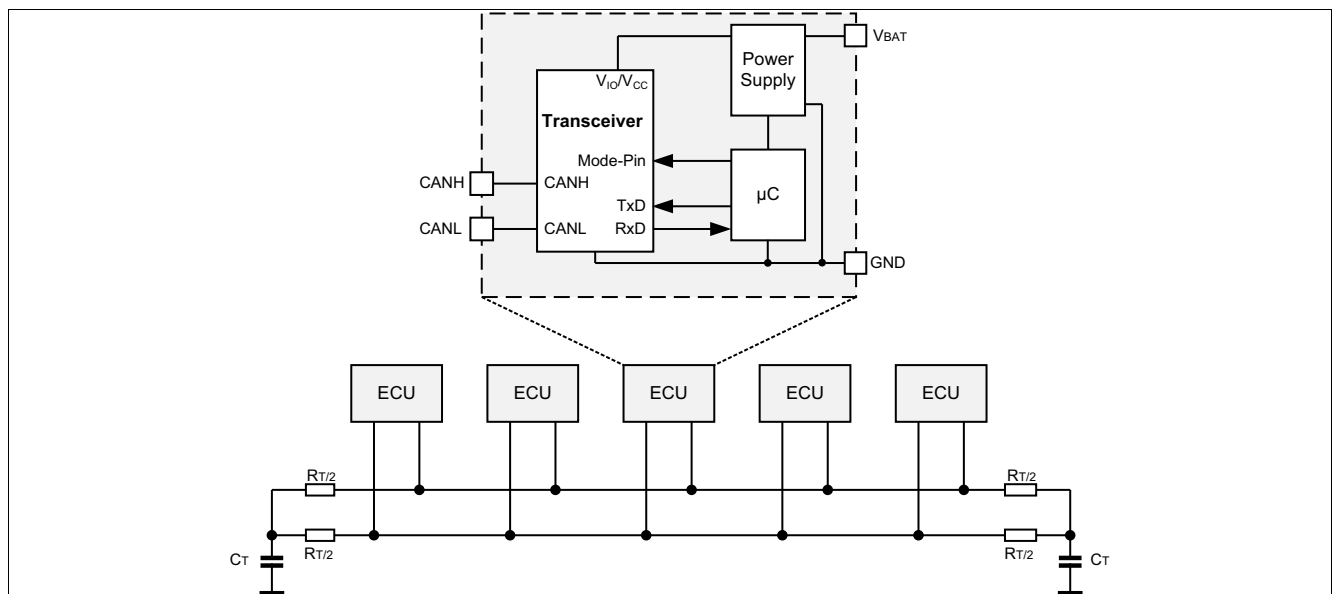


Figure 1 CAN Example with Typical ECU Using TLE7251V

The CAN bus physical layer has two defined states: dominant and recessive. In recessive state CANH and CANL are biased to $V_{CC}/2$ (typ. 2.5 V) and the differential output voltage V_{Diff} is below 0.5 V.

A “low” signal applied to Tx/D pin generates a dominant state on CANH and CANL. The voltage on CANH changes towards V_{CC} and CANL goes towards GND. The differential voltage V_{Diff} is higher than 0.9 V.

CAN Application

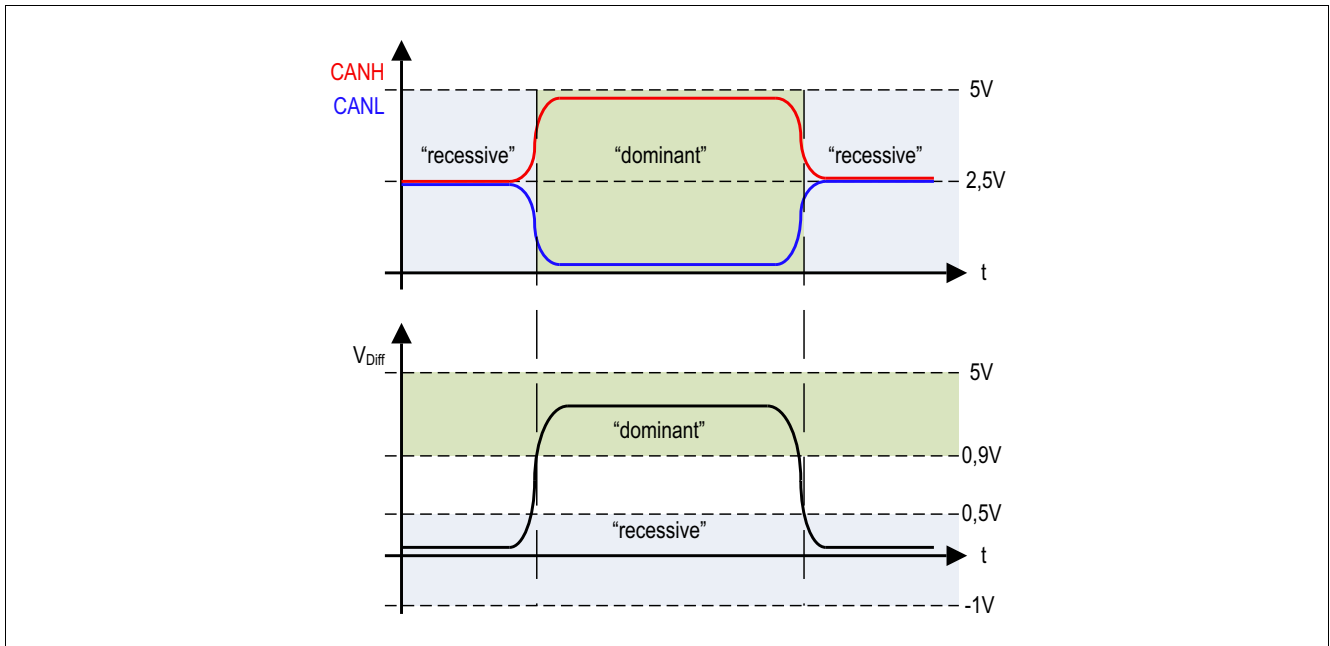


Figure 2 Voltage Levels according to ISO 11898-2

Table 1 Voltage Levels according to ISO 11898-2

Parameter	Symbol	Values			Unit	Note or Test Condition
		Min.	Typ.	Max.		
Recessive State						
Output Bus Voltage	$V_{CANL,H}$	2.0	2.5	3.0	V	No load
Differential Output Bus Voltage	$V_{Diff_R_NM}$	-500	-	50	mV	No load
Differential Input Bus Voltage	$V_{Diff_R_Range}$	-1.0	-	0.5	V	-
Dominant State						
Output Bus Voltage	V_{CANH}	2.75	3.5	4.5	V	$50 \Omega < R_L < 65 \Omega$
	V_{CANL}	0.5	1.5	2.25	V	$50 \Omega < R_L < 65 \Omega$
Differential Output Bus Voltage	$V_{Diff_D_NM}$	1.5	2.0	3.0	V	$50 \Omega < R_L < 65 \Omega$
Differential Input Voltage	$V_{Diff_D_Range}$	0.9	-	5.0	V	-

The CAN physical layer is described in ISO 11898-2. The CAN transceiver TLE7251V fulfills all parameters defined in ISO 11898-2. This document describes CAN applications with the TLE7251V. It provides application hints and recommendations for the design of CAN electronic control units (ECUs) using the CAN transceiver TLE7251V from Infineon Technologies AG.

TLE7251V Description

2 TLE7251V Description

The transceiver TLE7251V represents the physical medium attachment, interfacing the CAN protocol controller to the CAN transmission medium. The transmit data stream of the protocol controller at the TxD input is converted by the CAN transceiver into a bus signal. The receiver of the TLE7251V detects the data stream on the CAN bus and transmits it via the RxD pin to the protocol controller.

2.1 Features

The main features of the TLE7251V are:

- Baud rate up to 2 Mbit/s
- Very low Electromagnetic Emission (EME) and high Electromagnetic Immunity (EMI)
- Excellent ESD performance according to HBM (+/-9 kV) and IEC (+/-8 kV)
- Very low current consumption in Stand-by mode
- Transmit data (TxD) dominant time-out function
- Supply voltage range 4.5 V to 5.5 V
- Control input levels compatible with 3.3 V and 5 V devices
- Remote wake-up in Stand-by mode
- Thermal shutdown protection

2.2 Mode Description

The TLE7251V supports three different modes of operation. The mode of operation depends on the status of the reference power supply and the status of the mode selection pin STB:

- Normal-operating mode: Used for communication on the HS CAN bus. Transmit and receive data on the bus.
- Stand-by mode: This mode is used in order to set the ECU in low-power mode in permanently supplied networks. Current consumption is reduced to a minimum, while the TLE7251V can still detect a bus wake-up and to wake up the ECU.
- Forced-stand-by mode: Same behavior as Stand-by mode. Forced-stand-by mode is a fail safe mode. The transmitter is disabled. The bus wake-up feature for V_{CC} undervoltage condition is enabled.

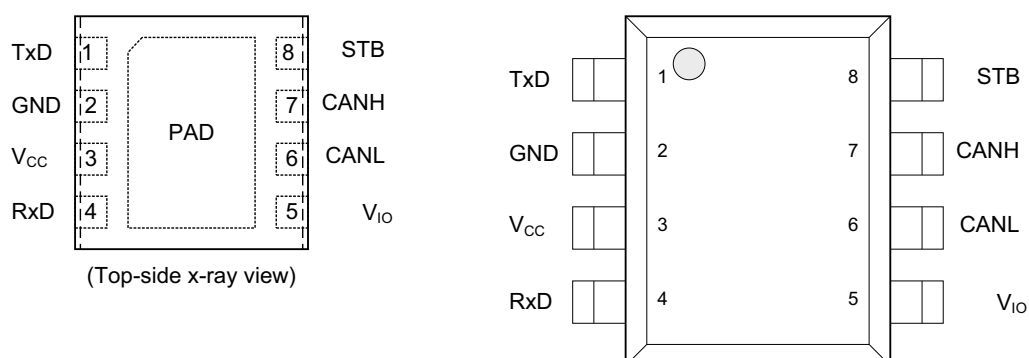


Figure 3 Pin Configuration of the TLE7251V

3 In Vehicle Network Applications

The TLE7250/51-Family offers a perfect match for various ECU requirements. For permanently supplied ECUs (Clamp 30) as well as for partially supplied ECUs (Clamp 15) the TLE7251V is suitable. According to the requirements of automobile manufacturers, the modules can either be permanently supplied or unsupplied during the car is parked. The main reason for unsupplied modules is saving battery energy. Permanently supplied modules can wake up quickly via CAN message.

3.1 Clamp 30 and Clamp 15

Clamp 30:

Permanently supplied modules, even when the car is parked are required by body applications such as door modules, RF keyless entry receivers, etc. Modules are directly connected to the battery. This supply line is called clamp 30. As battery voltage is present permanently, the voltage regulator, transceiver and microcontroller are always supplied. Therefore voltage regulator, transceiver and microcontroller need to be set to low-power mode in order to reduce current consumption to a minimum.

Clamp 15:

Partially supplied modules are typically used in under hood applications such as ECUs. When the car is parked a main switch or ignition key switches off the battery supply. This supply line is called clamp 15. When the battery voltage is not present, the voltage regulator and transceiver are switched off.

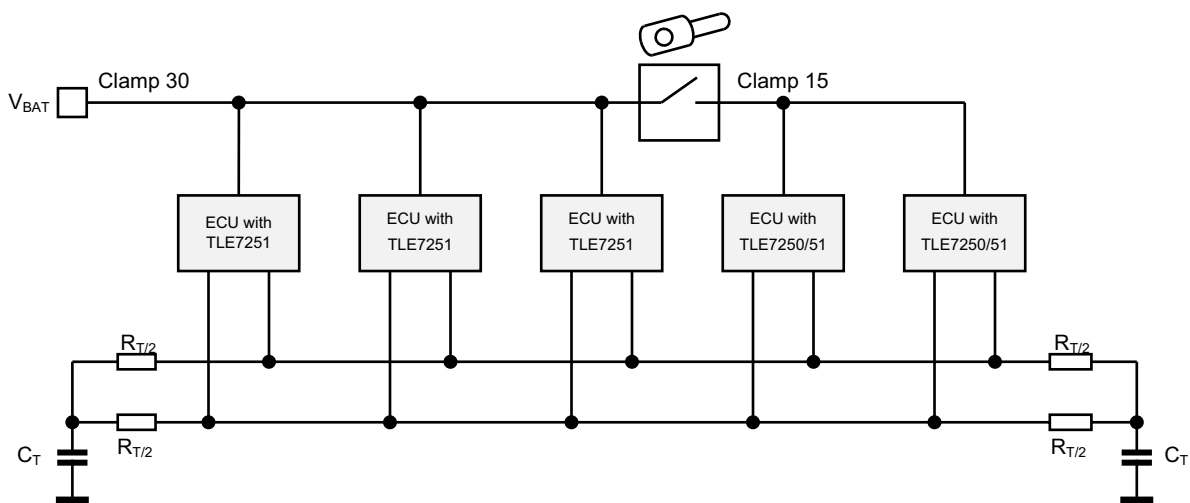


Figure 4 CAN with ECUs Using TLE7251V

In Clamp 30 applications the most important feature is very low current consumption in order to prevent the battery from discharging. Therefore the low-power mode of an ECU can be used. TLE7251V offers the Stand-by mode with optimized very low current consumption. In Stand-by mode the TLE7251V can still detect a bus wake-up. If bus communication is monitored on the HS CAN bus, then the TLE7251V indicates this wake-up event on the RxD output pin. This wakes up the microcontroller and the ECU starts working normally. TLE7251V can also be used in clamp 15 applications. The modes of operation are described in [Chapter 2.2](#).

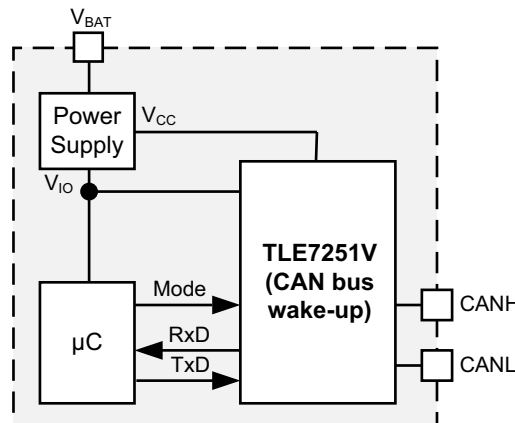


Figure 5 Example ECU with TLE7251V

3.2 Baud Rate versus Bus Length

Table 2 Recommended Baud Rate versus Bus Length

Baud Rate (kbit/s)	Bus Length (m) Maximum Distance between two Nodes
1000	10
500	40
250	120
125	500
50	1000

Baud rate is limited by:

- bus length
- ringing
- propagation delay of cables
- propagation delay of the CAN controller of the transceiver

The two most distant nodes (A and B) in a CAN network are the limiting factor in transmission speed. The propagation delays must be considered because a round trip has to be made from the two most distant CAN controllers on the bus.

Worst case scenario: When node A starts transmitting a dominant signal, it takes a certain period of time ($t = t_{\text{CANcontroller}} + t_{\text{Transceiver}} + t_{\text{Cable}}$) until the signal arrives at node B.

The propagation delay is estimated by: CAN controller delay, transceiver delay, bus length delay. Assumption: 70 ns for CAN controller, 255 ns for transceiver, 5 ns per meter of cable. Example with 50 m cable length:

$$t_{\text{prop}} = t_{\text{CANcontroller}} + t_{\text{Transceiver}} + t_{\text{Cable}} + t_{\text{CANcontroller}} + t_{\text{Transceiver}} + t_{\text{Cable}} = 70 \text{ ns} + 255 \text{ ns} + 50 \text{ m} \times 5 \text{ ns/m} + 70 \text{ ns} + 255 \text{ ns} + 50 \text{ m} \times 5 \text{ ns/m} = 1150 \text{ ns}$$

Some other factors of great influence on the maximum baud rate are cable capacitance, oscillator tolerance, ringing and reflection effects depending on the network topology. In addition to theoretical maximum propagation delay all other effects must be taken into account and an additional margin of safety must be added. Wire resistance increases with bus length and therefore the bus signal amplitude may be degraded.

CAN FD

4 CAN FD

CAN FD (Flexible Data Rate) is the advanced version of classical CAN. Classical CAN is specified by ISO 11898-2 for data transmission rate up to 1 Mbit/s. For CAN FD with higher data transmission rate (2 Mbit/s) ISO 11898-2 specifies additional timing parameters. CAN FD uses the same physical layer as classical CAN does, but allows higher data transmission rate and increased payload per message. During the arbitration phase and checksum the data transmission rate is the same as for classical CAN (1 Mbit/s). As soon as one node in the CAN FD network starts transmitting the payload, the data rate increases (2 Mbit/s). The increase in baud rate is possible as only one node transmits during the data transmission phase. All other nodes listen to the data on the CAN bus. Instead of 8 bytes per message (classical CAN) payload is increased up to maximum 64 byte per message. Using CAN FD saves transmission time and allows increased data payload. In order to ensure reliable data transmission, CAN FD requires a CAN transceiver with full ISO 11898-2 specification for Flexible Data rate up to 2 Mbit/s.

The TLE7251V from Infineon Technologies AG is the perfect match for CAN FD networks. TLE7251V fulfills or exceeds all classical CAN and CAN FD parameters of ISO 11898-2 in order to enable smooth and safe usage within applications.

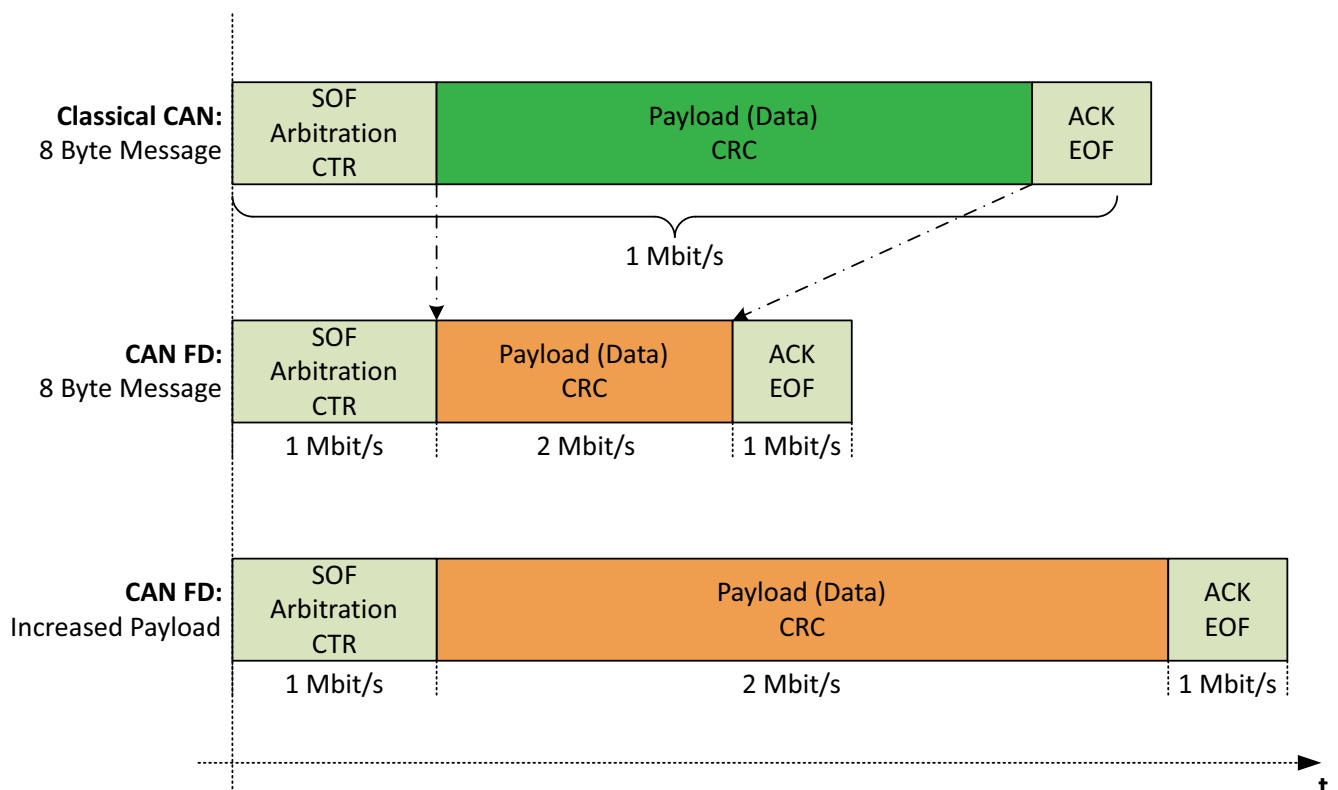


Figure 6 Classical CAN Data Rate and CAN FD Data Rate

5 Pin Description

5.1 V_{IO} Pin

The V_{IO} pin is needed for the operation with a microcontroller that is supplied by $V_{IO} < V_{CC}$, to get the correct level between microcontroller and transceiver. It can also be used to decouple microcontroller and transmitter supply. This concept improves EMC performance and the transmitter supply V_{CC} can be switched off separately.

The digital reference supply voltage V_{IO} has two functions:

- supply of the internal logic of the transceiver (state machine)
- voltage adaption for external microcontroller ($3.0\text{ V} < V_{IO} < 5.5\text{ V}$)

As long as V_{IO} is supplied ($V_{IO} > 3.0\text{ V}$) the state machine of the transceiver works and mode changes can be performed. If a microcontroller uses low $V_{IO} < V_{CC} = 5\text{ V}$, then the V_{IO} pin must be connected to the power supply of the microcontroller. Due to this feature, the TLE7251V can work with various microcontroller supplies. If V_{IO} is available, then both transceiver and microcontroller are fully functional. Below $V_{IO} < 3.0\text{ V}$ the TLE7251V is in Power On Reset state. To enter Normal-operating mode $V_{IO} > 3.0\text{ V}$ is required.

5.2 V_{CC} Pin

The V_{CC} pin supplies the transmitter output stage. The transmitter operates according to data sheet specifications in the voltage range of $4.5\text{ V} < V_{CC} < 5.5\text{ V}$. Voltage $V_{CC} > 6\text{ V}$ can damage the device. If $V_{CC} < V_{CC_UV}$, then the transmitter is disabled. The undervoltage threshold V_{CC_UV} is in the range from 3.65 V to 4.3 V. If $V_{CC_UV} < V_{CC} < 4.5\text{ V}$, then the transmitter is enabled and can then send data to the bus, but parameters may be outside the specified range.

5.3 STB Pin

The STB pin sets the mode of TLE7251V and is usually directly connected to an output port of a microcontroller. If the mode pin is unconnected and TLE7251V is supplied by V_{IO} , then the device enters Stand-by mode due to the internal pull-up resistor to V_{IO} . The purpose of the Stand-by mode is to reduce current consumption, while the TLE7251V can still detect a bus wake-up. To put the device into Normal-operating mode for transmitting and receiving data, the STB pin must be set to “low”. The user can deactivate transmitter and receiver of TLE7251V either by setting the STB pin to “high” or by switching off V_{CC} . This can be used to implement two different fail safe paths in case a failure is detected in the ECU. [Table 3](#) shows mode changes by the STB pin, assuming $V_{IO} > V_{IO_UV}$. Features and modes of operation are described in [Chapter 2](#).

Table 3 Mode Selection by STB

Mode of operation	STB	V_{CC}	Comment
Stand-by mode	“high”	“X”	TLE7251V monitors the bus for a valid wake-up pattern and indicates wake-up detection on the RxD output pin. In this mode V_{CC} is not required
Forced-stand-by mode	“low”	$< V_{CC_UV}$	Same as Stand-by mode
Normal-operating mode	“low”	$> V_{CC_UV}$	If $V_{CC} > V_{CC_UV}$, then the transmitter is enabled.

5.4 TxD Pin

TxD is an input pin. TxD pin is used to receive the data stream from the microcontroller. If $V_{IO} > V_{IO_UV}$, then the data stream is transmitted to the HS CAN bus. A “low” signal causes a dominant state on the bus and a “high”

Pin Description

signal causes a recessive state on the bus. The “high” signal must be adapted according to the voltage on the V_{IO} pin. This means the “high” level must not exceed V_{IO} voltage. The TxD input pin has an integrated pull-up resistor to V_{IO} . If TxD is permanently “low”, for example due to a short circuit to GND, then the TxD time-out feature will block the signal on the TxD input pin (see [Chapter 8.1](#)). It is not recommended to use a series resistor within the TxD line between transceiver and microcontroller. A series resistor may add delay, which degrades the performance of the transceiver, especially in high data rate applications. The data stream sent from the microcontroller to the TxD pin of the transceiver is only transmitted to the HS CAN bus in Normal-operating mode. In all other modes the TxD input pin is blocked.

5.5 RxD Pin

RxD is an output pin. The data stream received from the HS CAN bus is displayed on the RxD output pin in Normal-operating mode. If a bus wake-up is detected in Stand-by mode or in Forced-stand-by mode, then the RxD pin is “high” and switches to “low” and follows the bus with the parameters of the low-power receiver specified in the datasheet. It is not recommended to use a series resistor within the RxD line between transceiver and microcontroller. A series resistor may add delay, which degrades the performance of the transceiver, especially in high data rate applications.

5.6 CANH and CANL Pins

CANH and CANL are the CAN bus input and output pins. The TLE7251V is connected to the bus via pin CANH and CANL. Transmitter output stage and receiver are connected to CANH and CANL. Data on the TxD pin is transmitted to CANH and CANL and is simultaneously received by the receiver input and signalled on the RxD output pin. For achieving optimum EME (Electromagnetic Emission) performance, transitions from dominant to recessive and from recessive to dominant are done as smooth as possible also at high data rate. Output levels of CANH and CANL in recessive and dominant state are described in [Table 1](#). Due to the excellent ESD performance on CANH and CANL no external ESD components are necessary to fulfill OEM requirements.

5.7 GND Pin

The GND pin must be connected as close as possible to module ground in order to reduce ground shift. It is not recommended to place filter elements or an additional resistor between GND pin and module ground. GND must be the same for transceiver, microcontroller and HS CAN bus system.

6 Transceiver Supply

The internal logic of TLE7251V is supplied by the V_{IO} pin. The V_{CC} pin 5 V supply is used to create the CANH and CANL signal. The transmitter output stage as well as the main CAN bus receiver are supplied by the V_{CC} pin. This chapter describes aspects of power consumption and voltage supply concepts of TLE7251V.

6.1 Voltage Regulator

It is recommended to use one of the following Infineon low drop output (LDO) voltage regulators, depending on the V_{IO} power supply concept:

- 3.3 V V_{IO} power supply: TLS850D0TAV33 (500mA)¹⁾, TLS850F0TAV33 (500mA)¹⁾, TLS810B1LDV33²⁾ (100mA), [TLE4266-2GS V33](#) (150mA),
- 5 V V_{IO} and V_{CC} power supply: TLS850D0TAV50¹⁾ (500mA), [TLS850F0TA V50](#) (500mA), [TLS810D1EJV50](#) (100mA), [TLS810B1LDV50](#) (100mA), [TLE4266-2](#) (150mA)
- 3.3 V and 5 V dual voltage power supply: [TLE4476D](#)
- Dual 5V voltage power supply: [TLE4473GV55](#)

Please refer to [Infineon Linear Voltage Regulators](#) for the Infineon voltage regulator portfolio, data sheets and application notes.

6.2 External Circuitry

In order to reduce EME and to improve the stability of input voltage level on V_{CC} and V_{IO} of the transceiver, it is recommended to place capacitors on the PCB. During sending a dominant bit to the HS CAN bus, current consumption of TLE7251V is higher than during sending a recessive bit. Data transmission can change the load profile on V_{CC} . Changes in load profile may reduce the stability of V_{CC} . If several CAN transceivers are connected in parallel, and if these CAN transceivers are supplied by the same V_{CC} and/or V_{IO} power supply (for example LDO), then the impact on the stability of V_{CC} is even stronger. It is recommended to place a 100 nF capacitor as close as possible to V_{CC} and V_{IO} pin. The output of the V_{CC} and V_{IO} power supply (for example LDO) must be stabilized by a capacitor in the range of 1 to 50 μ F, depending on the load profile. Ceramic capacitors are recommended for low ESR.

6.3 V_{IO} Feature

TLE7251V offers a V_{IO} supply pin, which is a voltage reference input for adjusting the voltage levels on the digital input and output pins to the voltage supply of the microcontroller. In order to use the V_{IO} feature, connect the power supply of the microcontroller to the V_{IO} input pin. Depending on the voltage supply of the microcontroller, TLE7251V can operate with the V_{IO} reference voltage input within the voltage range from 3.0 V to 5.5 V.

6.3.1 V_{IO} 3.3 V - 5.5 V Power Supply Concept

The V_{IO} pin supplies the internal logic of the TLE7251V. TLE7251V can operate with the V_{IO} reference voltage input in the range from 3.0 V to 5.5 V. The V_{CC} pin (typ. = 5 V) supplies the transmitter of TLE7251V. Therefore the V_{CC} supply input pin must be connected to a 5 V voltage regulator. Competitor devices use V_{CC} to supply the internal logic and the transmitter output stage and V_{IO} as a simple level shifter. Infineon's HS CAN transceivers can work in V_{CC} undervoltage condition or even with V_{CC} completely switched off in Forced-stand-by mode and Stand-by Mode.

1) Planned SOP Q2 2016

2) Planned SOP Q4 2016

6.3.2 V_{IO} 3.3 V Power Supply

In order to reduce power consumption of ECU, the microcontroller might not be supplied by V_{CC} but by a lower voltage (for example 3.3 V). Therefore the TLE7251V offers a V_{IO} supply pin, which is a voltage reference input in order to adjust the voltage levels on the digital input and output pins to the voltage supply of the microcontroller. The V_{IO} feature enables the TLE7251V to operate with a microcontroller, which is supplied by a voltage lower than V_{CC} . With the V_{IO} reference voltage input the TLE7251V can operate from 3.0 V to 5.5 V.

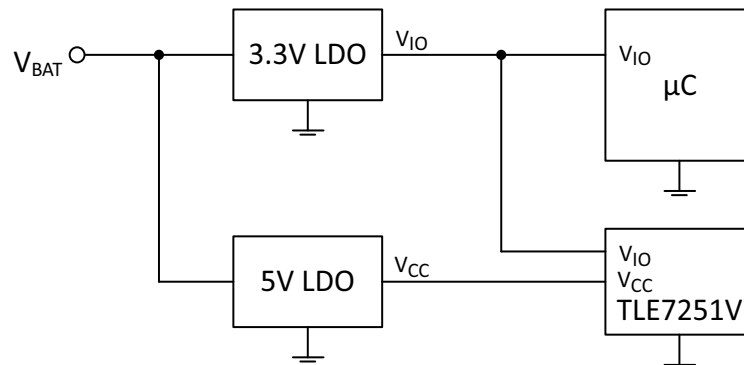


Figure 7 3.3 V Power Supply Concept

6.3.3 V_{IO} 5 V Supply

TLE7251V can also operate with a 5 V supply because of the V_{IO} input voltage range from 3.0 V to 5.5 V. If the microcontroller uses $V_{CC} = 5$ V supply, then V_{IO} is connected to V_{CC} . The V_{IO} input must be connected to the supply voltage of the microcontroller.

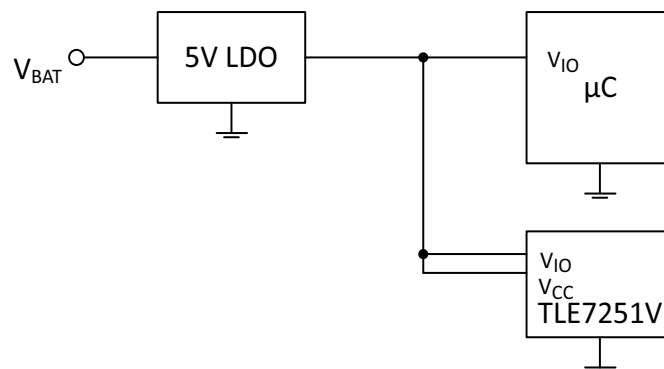


Figure 8 5 V Power Supply Concept

6.3.4 Dual 5 V Supply Concept

In order to decouple the microcontroller and the HS CAN Bus from each other with respect to noise and disturbances, it is possible to use a dual 5 V voltage regulator like [TLE4473GV55](#). In this case two independent 5 V LDOs supply V_{IO} and V_{CC} . This power supply concept improves EMC behavior and reduces noise.

Transceiver Supply

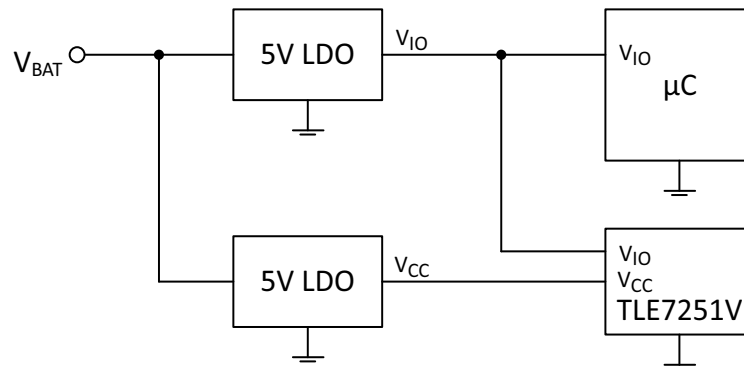


Figure 9 Dual 5 V Power Supply Concept

6.4 Current Consumption

Current consumption depends on the mode of operation:

- Normal-operating mode:

Maximum current consumption of TLE7251V on the V_{CC} supply is specified as 60 mA in dominant state and 4 mA in recessive state. Maximum current consumption of TLE7251V on the V_{IO} supply is specified as 1 mA. To estimate theoretical current consumption in Normal-operating mode, a duty cycle of 50% can be assumed, with fully loaded bus communication of 50% dominant and 50% recessive. In Normal-operating mode the TLE7251V consumes in worst case maximum:

$$I_{CC_AVG} = (I_{CC_REC} + I_{CC_DOM}) / 2 + I_{IO} = 32.5 \text{ mA}$$

Typically the current consumption is less than 15 mA.
- Stand-by mode and Forced-Stand-by mode:

Most of the functions are turned off but the TLE7251V monitors the HS CAN bus for a bus wake-up. In Stand-by mode the maximum current consumption is specified as $I_{IO,max} = 14 \mu\text{A}$ for $T < 150 \text{ }^\circ\text{C}$.

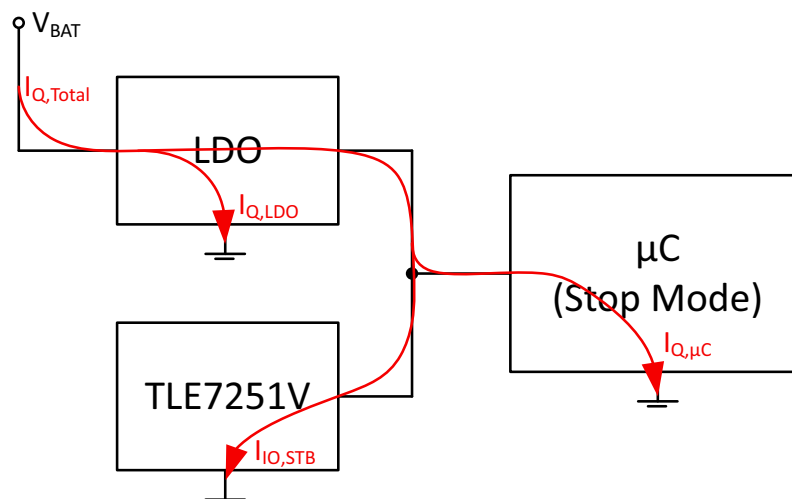


Figure 10 Quiescent Current Consumption in Stand-by Mode

6.5 Loss of Battery (Unsupplied Transceiver)

When TLE7251V is unsupplied, CANH and CANL act as high impedance. The leakage current $I_{CANH,IK}$, $I_{CANL,IK}$ at CANH pin or CANL pin is limited to +/- 5 μA in worst case. When unsupplied, TLE7251V behaves like a 1 M Ω resistor towards the bus. Therefore the device perfectly fits applications that use both Clamp 15 and Clamp 30.

6.6 Loss of Ground

If loss of ground occurs, then the transceiver is unsupplied and behaves like in unpowered state.

In applications with inductive load connected to the same GND, for example a motor, the transceiver can be damaged due to loss of ground. Excessive current can flow through the CAN transceiver when the inductor demagnetizes after loss of ground. The ESD structure of the transceiver cannot withstand that kind of Electrical Overstress (EOS). In order to protect the transceiver and other components of the module, an inductive load must be equipped with a free wheeling diode.

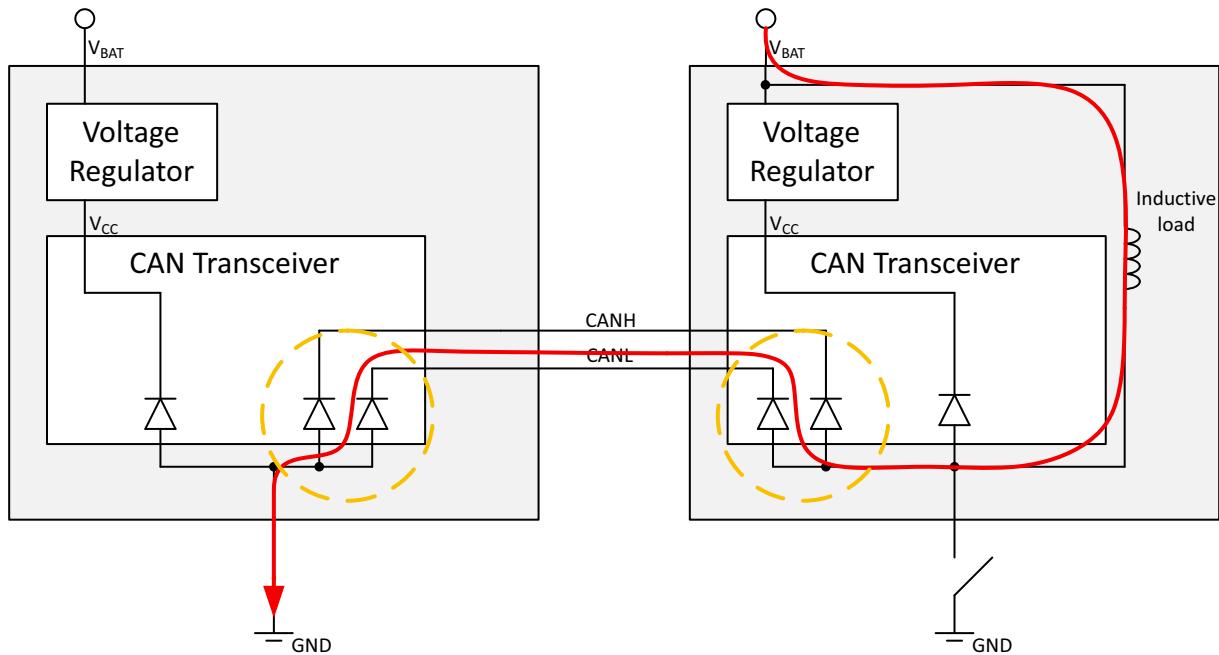


Figure 11 Loss of GND with Inductive Load

6.7 Ground Shift

Due to ground shift the GND levels of CAN transceivers within a network may vary. Ground shift occurs in high current applications or in modules with long GND wires. The receiver input stage acts like a resistor (R_i) to GND. Because the transmitting node has its GND shifted to V_{shift} , the recessive voltage level V_{rec} from the chassis ground is no longer 2.5 V but $V_{rec} + V_{shift}$. The same ground shift voltage V_{shift} must be taken into account for the dominant signal. Because CAN uses a differential signal and because of the wide common mode range of +/- 12 V for Infineon transceivers, any CANH and CANL DC value within absolute maximum ratings works.

The recessive CAN bus level V_{rec} during a ground shifted node transmitting is equal to the average recessive voltage level of all transceivers:

$$V_{rec} = [(V_{rec_1} + V_{shift_1}) + (V_{rec_2} + V_{shift_2}) + (V_{rec_3} + V_{shift_3}) + \dots + (V_{rec_n} + V_{shift_n})] / n$$

n : number of connected CAN nodes

$V_{rec_1}, V_{rec_2}, \dots, V_{rec_n}$: specific recessive voltage level of the transceiver at nodes 1, 2, .. n

$V_{shift_1}, V_{shift_2}, \dots, V_{shift_n}$: specific ground shift voltage level of the transceiver at nodes 1, 2, .. n

The supply current of a ground shifted transceiver increases by $I_{CC_shift} = V_{shift} / (R_{i_n} / n)$, assuming all input resistances at CANH and CANL of the transceivers are identical.

7 Transceiver Control

The modes of the TLE7251V are controlled by the pin STB and by transmitter voltage V_{CC} .

7.1 Mode Change by STB

The mode of operation is set by the mode selection pin STB. By default the STB input pin is “high” due to the internal pull-up resistor to V_{IO} .

The TLE7251V is in Stand-by mode independent of the status of V_{CC} . In order to change the mode to Normal-operating mode, STB must be switched to “low” and V_{CC} must be available.

7.2 Mode Change Delay

The HS CAN transceiver TLE7251V changes the mode of operation within the transition time period t_{Mode} . The transition time period t_{Mode} must be considered in developing software for the application. After the mode change from Stand-by mode to a non-low power mode the receiver and/or transmitter is enabled. When the mode change is completed, the TLE7251V releases the RxD output pin. **Figure 12** shows this scenario.

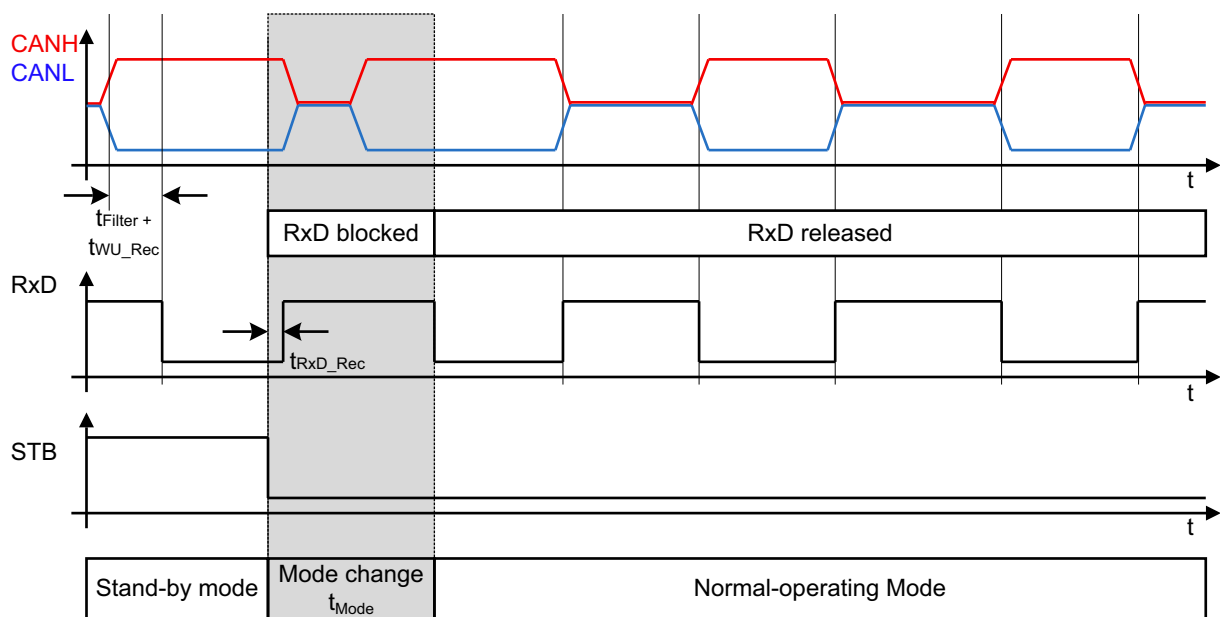


Figure 12 RxD Behavior during Mode Change

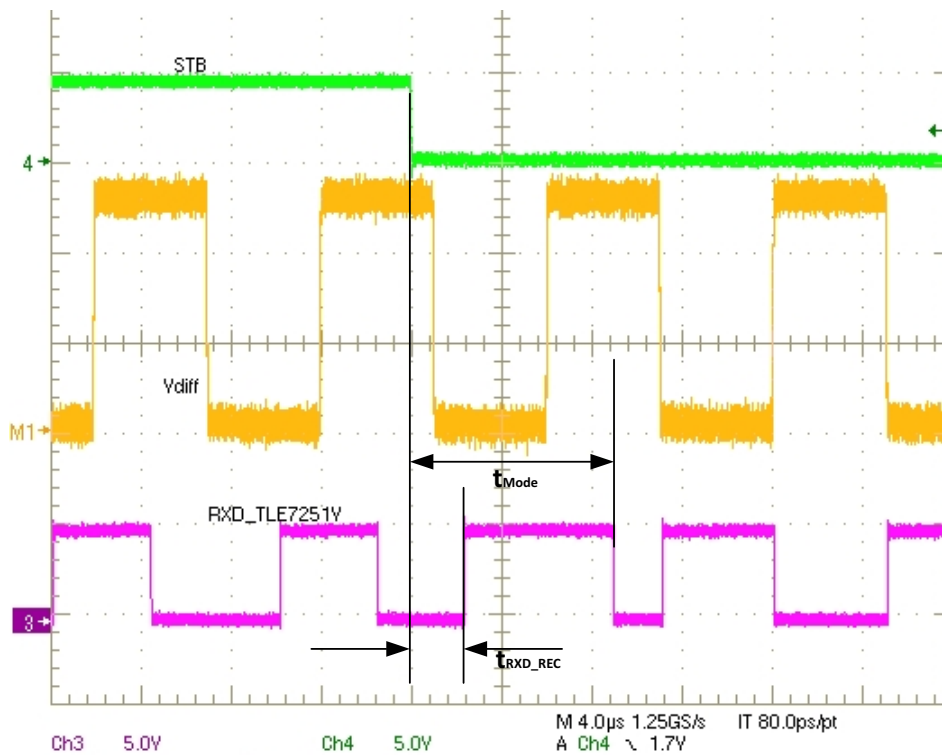


Figure 13 Communication on the CAN Bus: RxD Behavior during Mode Change (Stand-by Mode to Normal-Operating Mode)

7.3 Mode Change due to V_{CC} Undervoltage

A mode change due to V_{CC} undervoltage is only possible in Normal-operating mode. If V_{CC} undervoltage persists longer than $t_{Delay(UV)}$, then the TLE7251V changes from Normal-operating mode to Forced-stand-by mode. As soon as TLE7251V detects an undervoltage, it disables the transmitter output stage so that no faulty data is sent to the HS CAN bus.

In order to reduce current consumption during $V_{CC} < V_{CC(UV)}$ fault condition, the TLE7251V has a optimized current consumption in Forced-stand-by mode. In Forced-stand-by mode the TLE7251V detects a wake-up on the HS CAN bus and indicates the wake-up at RxD output pin.

If V_{CC} recovers, then $V_{CC} > V_{CC_UV}$ triggers a mode change back to Normal-operating mode.

Transceiver Control

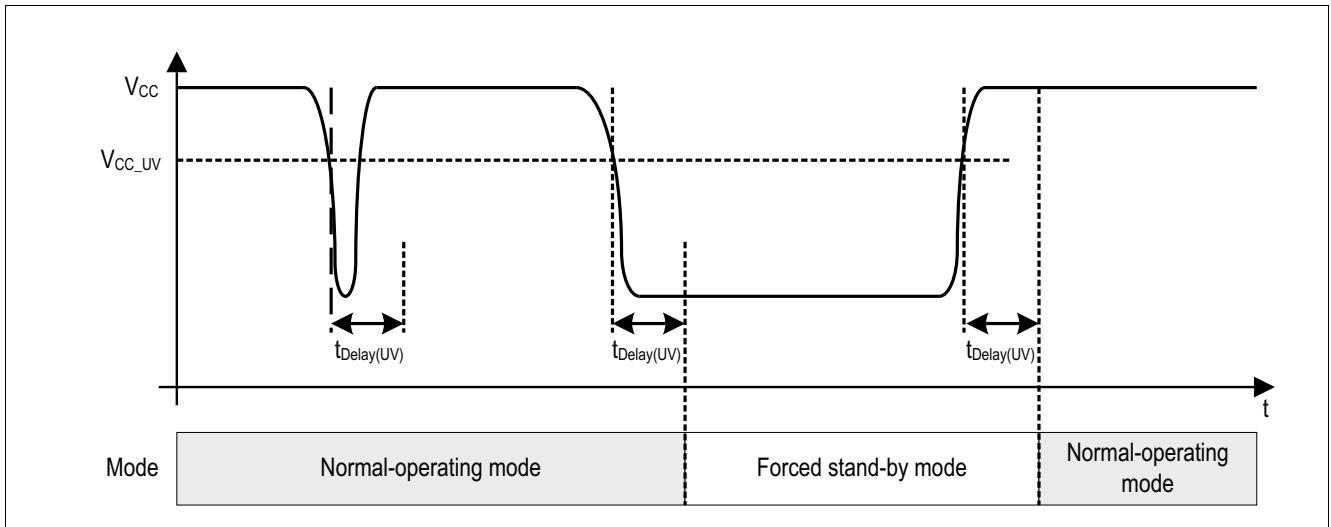


Figure 14 V_{CC} Undervoltage and Recovery

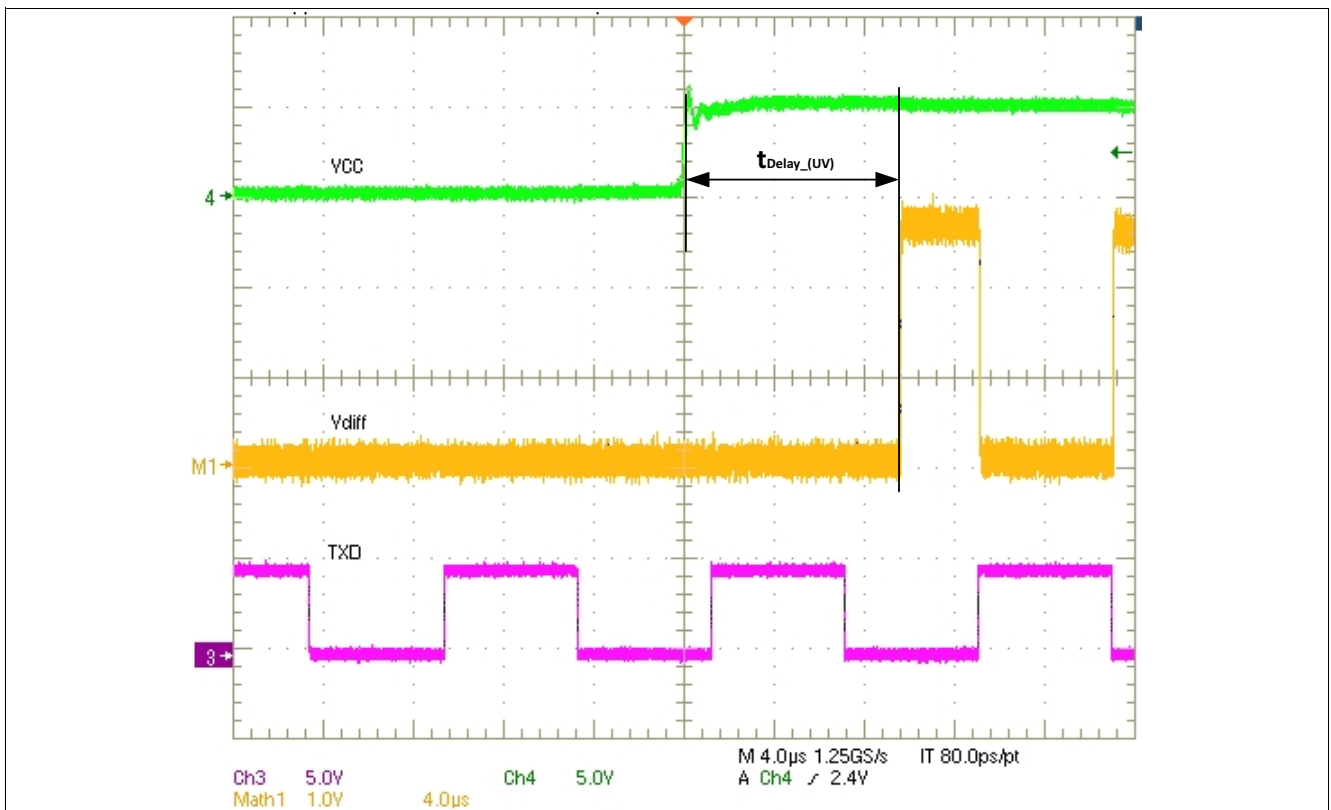


Figure 15 Recovery of V_{CC} in Forced Stand-by Mode

7.4 Remote Wake-up Detection

In order to reduce current consumption of permanently supplied applications (Clamp 30), ECUs are set to a low power mode. Low-power mode reduces quiescent current. Usually the microcontroller is in stop mode and the transceiver is Stand-by mode. In Stand-by mode the transceiver can wake up the microcontroller in order to set the ECU back to normal operation.

The TLE7251V has a remote wake-up feature. In Stand-by mode TLE7251V monitors activity on the CAN bus. If TLE7251V detects a wake-up pattern, then it indicates the wake-up signal on the RxD output pin. In Stand-by mode the transmitter supply V_{CC} can be turned off.

In Stand-by mode a wake-up event on the HS CAN is indicated on the RxD output pin. The transceiver remains in the current mode of operation.

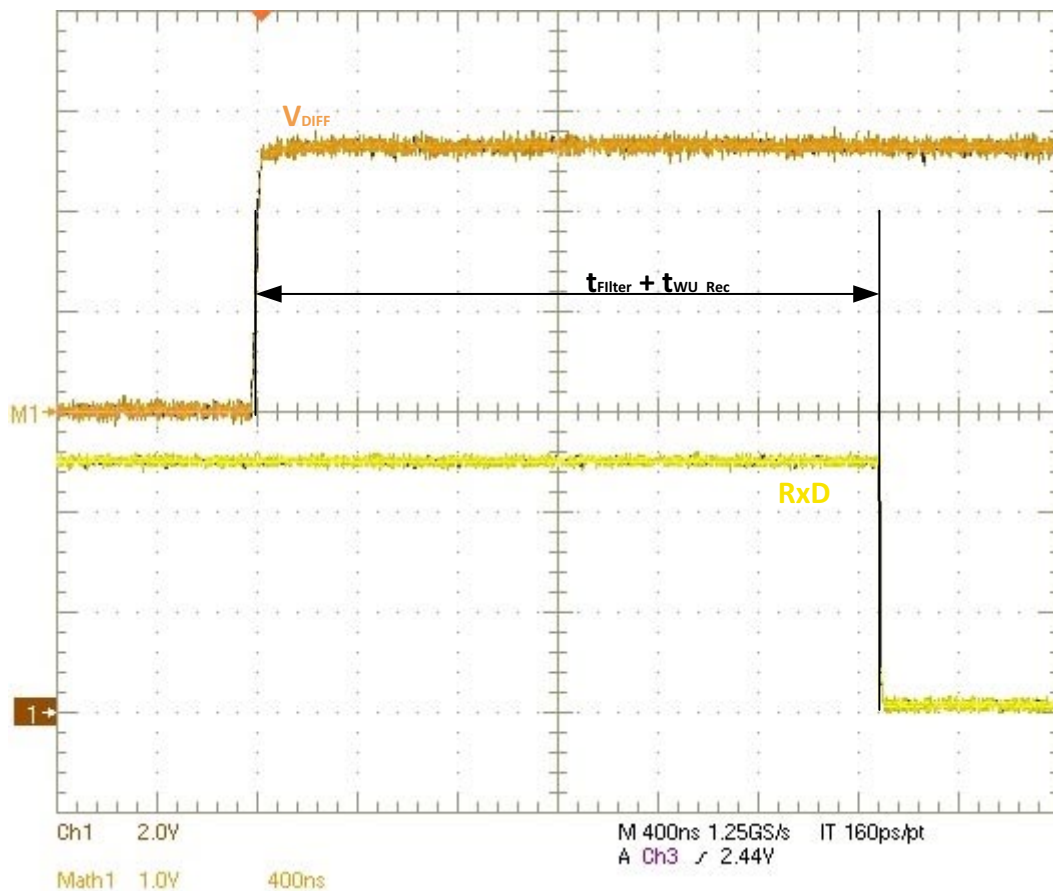


Figure 16 Remote Wake-up Detection

7.5 Advantage of V_{IO} -supplied Wake Receiver

Infineon's HS CAN transceivers use the V_{IO} pin to supply the low-power-receiver. For transceivers with bus wake-up TLE7251V, only V_{IO} must be supplied in Stand-by mode. The application saves current with the ECU in Stand-by mode while waiting for a bus wake-up.

In Stand-by mode V_{CC} can be switched off, while the receiver can still wake up the microcontroller via a bus wake-up. Common CAN transceivers use V_{CC} to supply both the receiver and the logic, thus requiring two voltage regulators in operation for V_{CC} and V_{IO} for detecting bus wake-up. This increases current consumption in Stand-by mode. With Infineon's TLE7251V the user can switch off the V_{CC} voltage regulator, so no permanent current $I_{BAT,LDO}$ flows to the 5 V LDO. A permanently flowing current through the V_{CC} -LDO might be an issue for the ECU's efficiency.

In order to take advantage of the bus wake-up feature, the microcontroller must set the TLE7251V to Stand-by mode by setting the STB pin to "high" and needs to switch off the V_{CC} LDO by a Control Output, before the microcontroller itself changes to low-power mode.

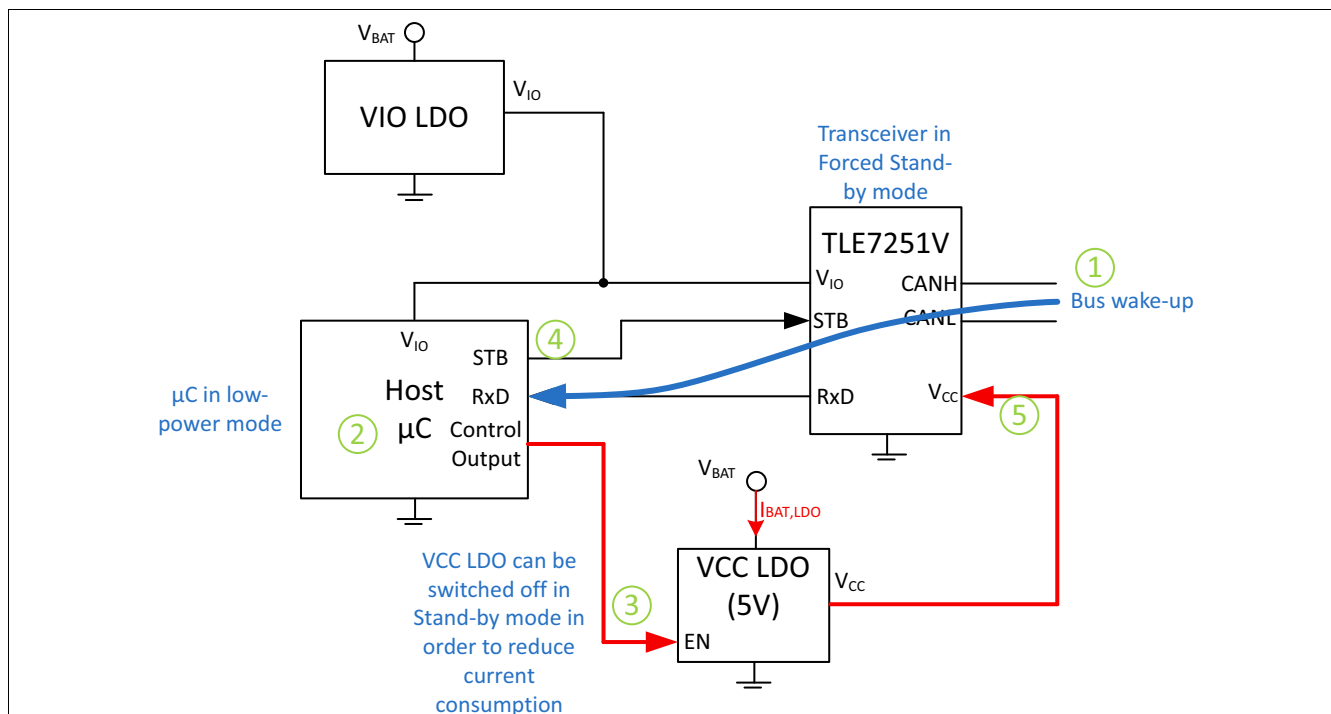


Figure 17 Advantage of V_{IO} -supplied Wake Receiver

Procedure for bus wake-up:

- 1) Bus-wake up is signaled by TLE7251V on the RxD output pin to the microcontroller
- 2) Microcontroller wakes up
- 3) Microcontroller must switch on the V_{CC} LDO by the Control Output
- 4) Then the STB input pin of TLE7251V must be changes to "low" in order to trigger a mode change to "Normal-operating mode"
- 5) After the mode change time t_{Mode} TLE7251V can send and receive data to the HS CAN Bus as soon as $V_{CC} > V_{CC_UV}$

7.6 Transition from Stand-by Mode to Forced-Stand-by Mode

From Normal-operating mode the TLE7251V enters Forced-stand-by mode on detecting V_{CC} undervoltage. However, in Stand-by mode V_{CC} undervoltage detection is disabled. With V_{CC} below the undervoltage threshold V_{CC_UV} in Stand-by mode, when STB is switched from "high" to "low" the TLE7251V changes to Normal-operating mode. In Normal-operating mode V_{CC} undervoltage detection is enabled, and thus the undervoltage event is detected. This in turn triggers a mode change to Forced-stand-by mode. The overall transition time period from Stand-by mode to Forced-stand-by mode is $t < t_{Mode}$. During the mode change from Power-save mode to Forced-receive-only mode the RxD output pin is permanently set to "high" and does not reflect the status of the CANH and CANL input pins. After mode change to Forced-stand-by mode is completed, the TLE7251V releases the RxD output pin.

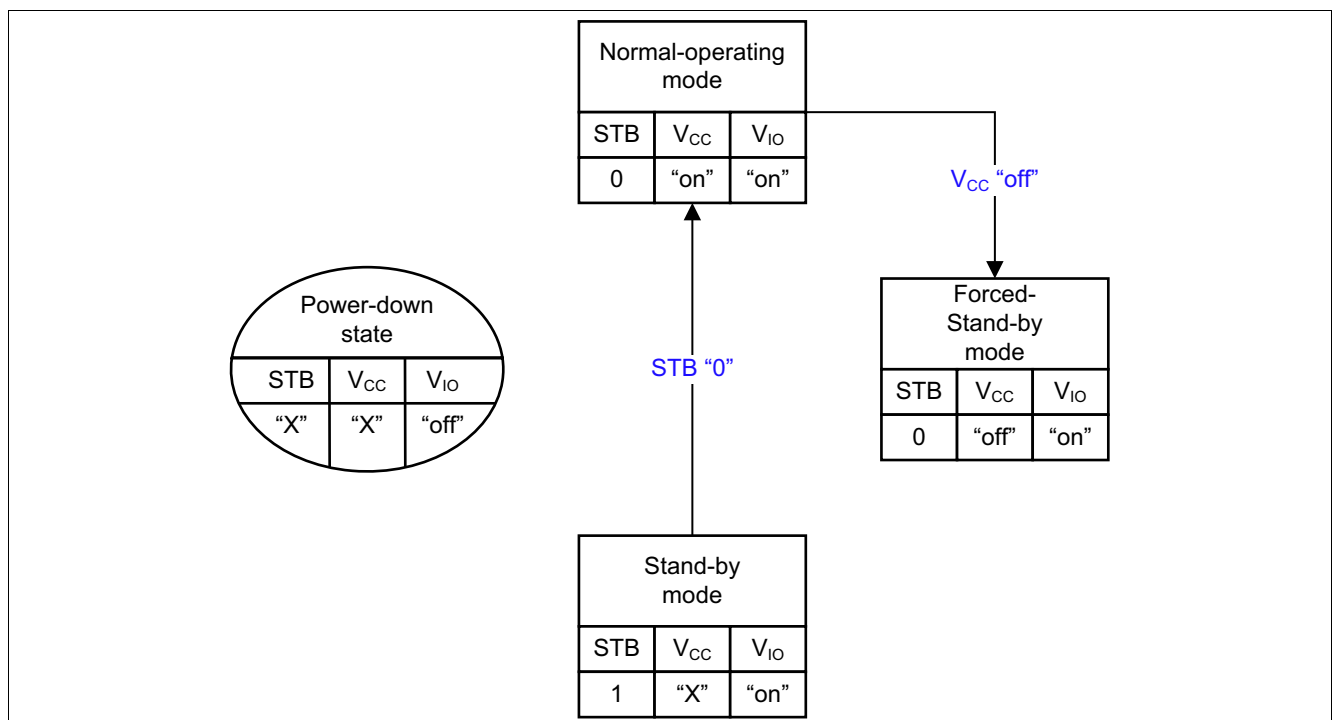


Figure 18 Stand-by Mode to Forced-Stand-by Mode

8 Failure Management

This chapter describes typical bus communication failures.

8.1 TxD Dominant Time-out Detection

The TxD dominant time-out detection of TLE7251V protects the CAN bus from being permanently driven to dominant level. When detecting a TxD dominant time-out, the TLE7251V disables the transmitter in order to release the CAN bus. Without the TxD dominant time-out detection, a CAN bus would be clamped to the dominant level and therefore would block any data transmission on the CAN bus. This failure may occur for example due to TxD pin shorted to ground.

The TxD dominant time-out detection can be reset after a dominant to recessive transition at the TxD pin. A “high” signal must be applied to the TxD input for at least $t_{\text{TxD_release}} = 200 \text{ ns}$ to reset the TxD dominant timer.

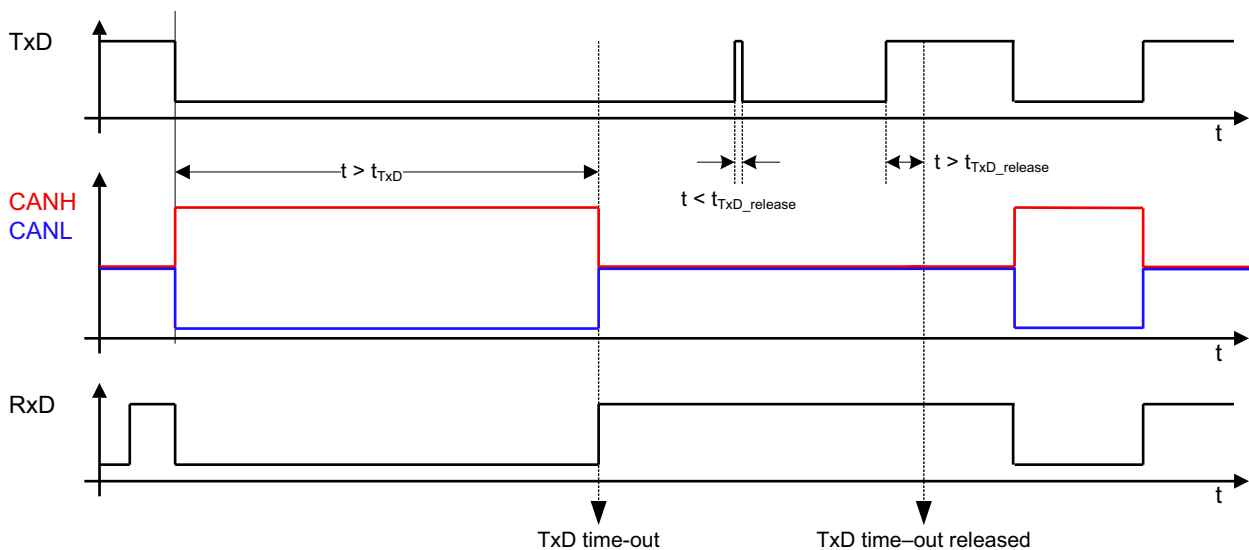


Figure 19 Resetting TxD Dominant Time-out Detection

If a TxD Dominant Time-out is present, then a mode change to Stand-by mode clears the TxD dominant timer state.

8.2 Minimum Baud Rate and Maximum TxD Dominant Phase

Due to the TxD dominant time-out detection of the TLE7251V the maximum TxD dominant phase is limited by the minimum TxD dominant time-out time $t_{\text{TxD}} = 4.5 \text{ ms}$. The CAN protocol allows a maximum of 11 subsequent dominant bits at TxD pin (worst case dominant bits followed immediately by an error frame). With a minimum value of 4.5 ms given in the datasheet and maximum possible 11 dominant bits, the minimum baud rate of the application must be higher than 2.44 kbit/s.

8.3 Short Circuit

Figure 20 shows short circuit types on the HS CAN bus. The CANH and CANL pins are short circuit proof to GND and to supply voltage. A current limiting circuit protects the transceiver from damage. If the device heats up due to a permanent short at CANH or CANL, then the overtemperature protection switches off the transmitter. Depending on the type of short circuit on CANH and CANL, communication might be still possible. If only CANL is shorted to GND or only CANH is shorted to V_{BAT} , then dominant and recessive states may be recognized by the receiver. Timings and/or differential output voltages might be not valid according to ISO11898 but still in the range for the receiver working properly.

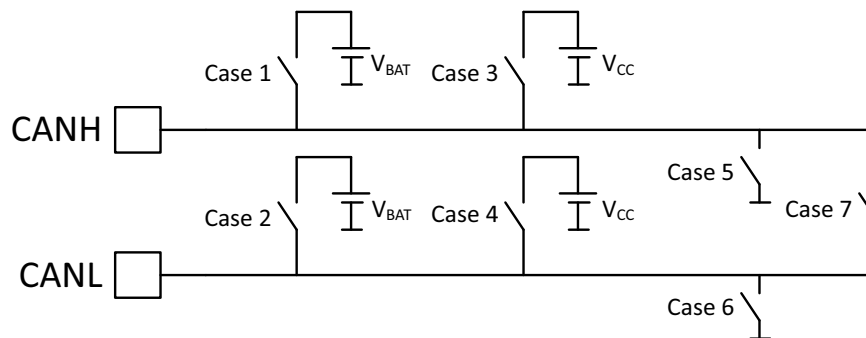


Figure 20 HS CAN Bus Short Circuit Types

Communication on the HS CAN bus is blocked in the following cases:

- CANH and CANL shorted (Case7)
- CANH shorted to GND (Case 5)
- CANL shorted to V_{BAT} (Case 2) or V_{CC} (Case 4)

If a short circuit occurs, the V_{CC} supply current for the transceiver can increase significantly. It is recommended to dimension the voltage regulator for the worst case, especially when V_{CC} also supplies the microcontroller. V_{CC} supply current only increases in dominant state. The recessive current remains almost unchanged.

CANH shorted to GND

The datasheet specifies a maximum short circuit current of 100mA. Transmitting a dominant state to the bus, 5V is shorted to GND through the transmitter output stage. Power dissipation with 10% duty cycle (DCD) is:

$$P = \text{DCD} \times U \times I = 0.1 \times 5V \times 100\text{mA} = 0.05\text{W}.$$

The average fault current with worst case parameters and assuming a realistic duty cycle of 10% is:

$$I_{CC,\text{Fault}} = I_{CC,\text{rec}} \times 0.9 + I_{\text{CANH,SC}} \times 0.1 = 13.6\text{mA}.$$

CANL shorted to V_{BAT}

If CANL is shorted to V_{BAT} , then the current through the CANL output stage is even higher and the device heats up faster. The datasheet specifies a maximum short circuit current of 100mA. When transmitting a dominant state to the bus, V_{BAT} is shorted to GND through the transmitter output stage. Assuming a realistic duty cycle of 10% for this case and the power dissipation is:

$$P = \text{DCD} \times U \times I = 0.1 \times V_{BAT} \times 100\text{mA} = 0.1 \times 18V \times 100\text{mA} = 0.18\text{W}.$$

CANH shorted to V_{BAT}

Short circuit of CANH to V_{BAT} can result in a permanent dominant state on the HS CAN bus, due to the voltage drop at the termination resistor. Therefore the termination resistor has to be chosen accordingly. If a short circuit of CANH to V_{BAT} occurs, then the power loss in the termination resistor must be taken into account. **Figure 21** shows the current in case CANH is shorted to V_{BAT} . When transmitting a dominant state to the bus, the current flows through the termination resistor and CANL to GND. Power loss in the termination resistor and

Failure Management

CANL assuming a battery voltage of 18 V and a duty cycle of 10% is:

$$P_{\text{Loss_Termination}} = 0.1 \times (R_{\text{Termination}} \times I_{\text{CANL,SC}}) \times I_{\text{CANL,SC}} = (60\Omega \times 100\text{mA}) \times 100\text{mA} = 0.6\text{W}$$

$$P_{\text{Loss_CANL}} = 0.1 \times (V_{\text{BAT}} - (R_{\text{Termination}} \times I_{\text{CANL,SC}})) \times I_{\text{CANL,SC}} = 0.1 \times (18\text{V} - 6\text{V}) \times 100\text{mA} = 0.1 \times 12\text{V} \times 100\text{mA} = 0.12\text{W}$$

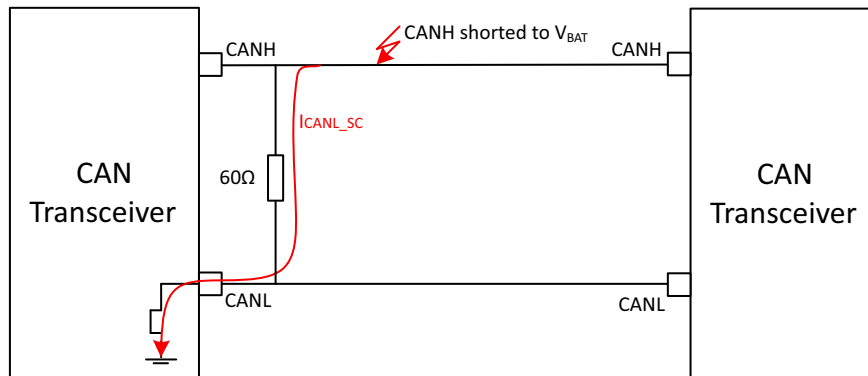


Figure 21 Current Flowing in Case of a Short Circuit CANH to V_{BAT}

8.4 TLE7251V Junction Temperature

In Normal-operating mode highest power dissipation occurs with 50% duty cycle (D) at an ambient temperature of 150 °C:

$$P_{\text{NM,MAX}} = D \times (I_{\text{CC,R}} \times V_{\text{CC,max}}) + D \times (I_{\text{CC,D}} \times V_{\text{CC,max}}) + (I_{\text{O}} \times V_{\text{IO,max}}) =$$

$$= 0.5 \times (4 \text{ mA} \times 5.5 \text{ V}) + 0.5 \times (60 \text{ mA} \times 5.5 \text{ V}) + (1.5 \text{ mA} \times 5.5 \text{ V}) = 184.25 \text{ mW}.$$

Junction temperature increases due to power dissipation and depending on the package.

However, typical conditions are more like this: ambient temperature is below 150 °C, overall duty cycle is less than 50%, and supply voltages V_{CC} and V_{IO} have their typical values instead of maximum values.

Power dissipation is much lower for such typical conditions:

$$P_{\text{NM,AVG}} = D \times (I_{\text{CC,R,Typ}} \times V_{\text{CC,AVG}}) + D \times (I_{\text{CC,D,Typ}} \times V_{\text{CC,AVG}}) + (I_{\text{O,Typ}} \times V_{\text{IO,AVG}}) =$$

$$0.9 \times (2 \text{ mA} \times 5 \text{ V}) + 0.1 \times (38 \text{ mA} \times 5 \text{ V}) + (1 \text{ mA} \times 3.3 \text{ V}) = 23.3 \text{ mW}.$$

Table 4 Increase of Junction Temperature ΔT_j

Package	R_{thja}	ΔT_j	Conditions
PG-DSO-8	120 K/W	22.1 K	$P_{\text{NM,MAX}} = 184.25 \text{ mW}$; $T_{\text{amb}} = 150 \text{ }^\circ\text{C}$;
PG-TSON-8	65 K/W	12 K	50% duty cycle; $V_{\text{CC}} = V_{\text{CC,max}}$; $V_{\text{IO}} = V_{\text{IO,max}}$
PG-DSO-8	120 K/W	2.8 K	$P_{\text{NM,AVG}} = 23.3 \text{ mW}$; $T_{\text{amb}} = 80 \text{ }^\circ\text{C}$;
PG-TSON-8	65 K/W	1.5 K	10% duty cycle; $V_{\text{CC}} = V_{\text{CC,typ}}$; $V_{\text{IO}} = V_{\text{IO,typ}}$
PG-DSO-8	120 K/W	6K	Short Circuit CANH to GND
PG-TSON-8	65 K/W	3.25K	10% duty cycle;
PG-DSO-8	120 K/W	21.62K	Short Circuit CANL to V_{BAT}
PG-TSON-8	65 K/W	11.72K	10% duty cycle;

If a short circuit occurs, then the TLE7251V heats up. The higher the duty cycle, the higher the power dissipation. If a thermal shutdown occurs due to high temperature, then the receiver is still enabled with only the transmitter disabled. The behavior is identical to Receive-only mode.

9 PCB Layout Recommendations for CAN FD

The following layout rules should be considered to achieve best performance of the transceiver and the ECU:

- TxD and RxD connections to microcontroller should be as short as possible.
- For each microcontroller the TxD driver output stage current capability may vary depending on the selected port and pin. The driver output stage current capability should be strong enough to guarantee a maximum propagation delay from μC port to transceiver TxD pin of less than 30ns.
- Place two individual 100nF capacitors close to V_{CC} and V_{IO} pins for local decoupling. Due to their low resistance and lower inductance compared to other capacitor types, it is recommended to use ceramic capacitors.
- If a common mode choke is used, it has to be placed as close as possible to the bus pins CANH and CANL.
- Avoid routing CANH and CANL in parallel to fast-switching lines or off-board signals in order to reduce noise injection to the bus.
- It is recommended to place the transceiver as close as possible to the ECU connector in order to minimize track length of bus lines.
- Avoid routing digital signals in parallel to CANH and CANL.
- CANH and CANL tracks should have the same length. They should be routed symmetrically close together with smooth edges.
- GND connector should be placed as close as possible to the transceiver.
- Avoid routing transceiver GND and microcontroller GND in series in order to reduce coupled noise to the transceiver. This also applies for high current applications, where the current should not flow through the GND line of transceiver and microcontroller in serial.
- Avoid routing transceiver V_{CC} supply and microcontroller V_{CC} supply in series in order to reduce coupled noise to the transceiver.
- Same dimensions and lengths for all wire connections from the transceiver to CMC and/or termination.
- In case an external ESD protection circuit is used, make sure the total capacitance is lower than 50pF. Use equal ESD protection for CANH and CANL in order to improve signal symmetry.
- For CAN FD application it is recommended to use a Common Mode Choke with 100 μH impedance and a Split termination with a capacitance of 4.7nF in order to achieve excellent EME performance in automotive applications.

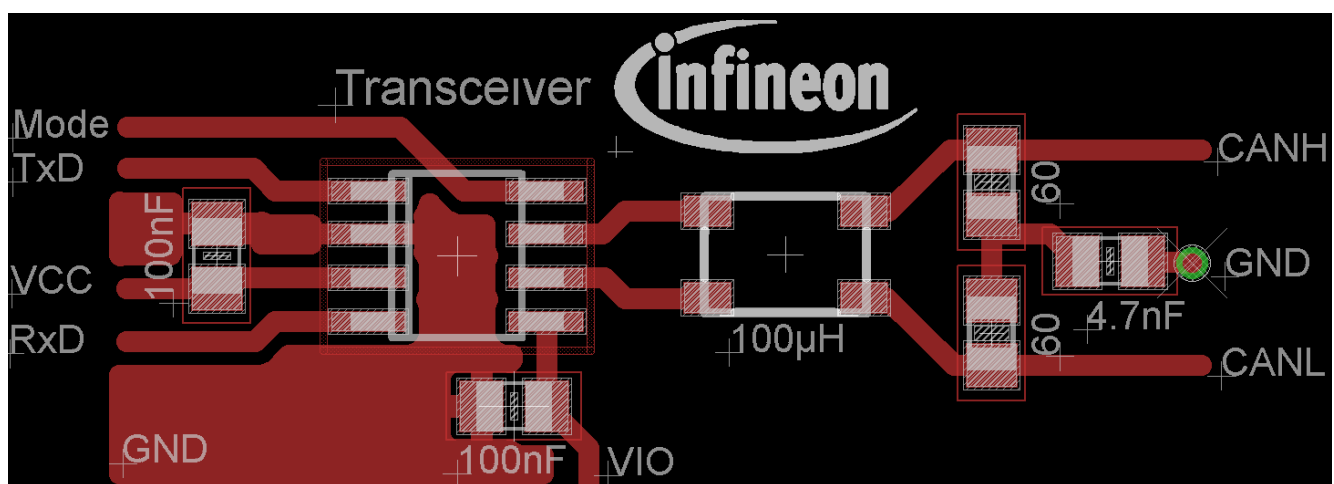


Figure 22 Example CAN transceiver PCB layout

References

10 References

- 1) [Data Sheet TLE7251VSJ / TLE7251VLE, HS CAN Transceiver, Infineon Technologies AG](#)
- 2) [White Paper - The CAN FD Physical Layer, Infineon Technologies AG](#)
- 3) [Infineon Automotive Transceivers Homepage](#)

Terms and Abbreviations

Table 5 Terms and Abbreviations

CMC	Common mode choke
EMC	Electromagnetic compatibility
EME	Electromagnetic emission
EMI	Electromagnetic interference
EOS	Electrical overstress
ESD	Electrostatic discharge
ESR	Equivalent Series Resistance
“high”	logical high
“low”	logical low

Revision History

11 Revision History

Revision	Date	Changes
1.2	2016-06-20	Editorial Changes; Added Chapter 9 PCB Layout Recommendations; Added Chapter 10 References;
1.1	2016-05-03	TxD Dominant time-out detection updated Figure 19 ;
1.0	2016-01-25	Application Note created

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